

# No solvents. No waiting. No worries.

**nyloflex<sup>®</sup>**  
**Xpress**  
Thermal Processing System

## nyloflex<sup>®</sup> Exposure F IV ECLF

Combined exposure and light finisher unit with reduced footprint and efficient design

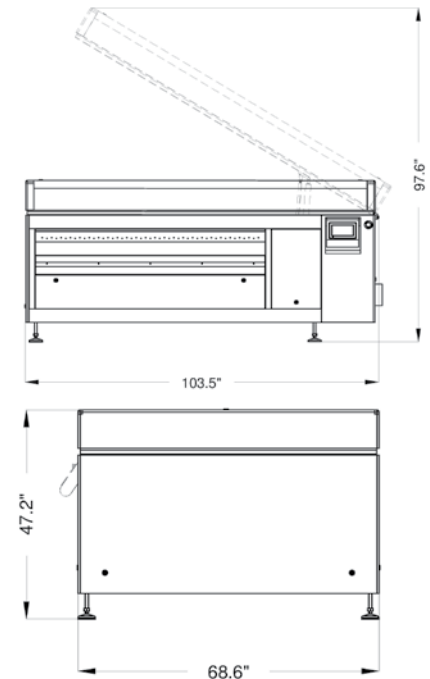


### Exposure section

- + Integrated bed chiller allows for uniform and consistent temperature without limiting exposure times
- + High concentration of UV-A lamps to ensure the highest UV output
- + Fibre optic to detect defective lamps
- + Air flow cooling system for exposure lamps with temperature control
- + Stores up to 24 different process conditions

### Light finishing section

- + One-drawer UV-A / UV-C post exposure and light finishing system
- + Includes air flow cooling system
- + Fibre optic to detect defective lamps



### Technical data

### nyloflex<sup>®</sup> Exposure F IV ECLF

Art. XG50-0004-V103

Maximum plate size (W x L)	1200 mm x 1600 mm (47" x 63")
Electrical connection	400 V, 50/60 Hz (3 Ph/N/PE) 230 V, 50/60 Hz (3 Ph/PE)
Nominal current	at 400 V: 15A at 230 V: 25A
Nominal power	9.5 kW
Compressed air	Min. 102 PSI (7 bar)
Exhaust air flow rate	Min. 590 CFM (1000 m <sup>3</sup> /h)
Weight	gross: 1400 kg (3090 lbs) net: 1120 kg (2472 lbs)
Crate dimensions (W x D x H)	2930 mm x 1930 mm x 1590 mm (116" x 76" x 63")

Please contact us for additional information.

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